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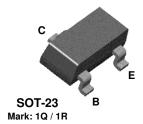
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## 2N5088 2N5089

## MMBT5088 MMBT5089





## **NPN General Purpose Amplifier**

This device is designed for low noise, high gain, general purpose amplifier applications at collector currents from  $1\mu A$  to 50 mA.

### Absolute Maximum Ratings\* TA

TA = 25°C unless otherwise noted

Symbol	pol Parameter		Value	Units
$V_{CEO}$	Collector-Emitter Voltage	2N5088 2N5089	30 25	V V
V <sub>CBO</sub>	Collector-Base Voltage	2N5088 2N5089	35 30	V V
V <sub>EBO</sub>	Emitter-Base Voltage		4.5	V
I <sub>C</sub>	Collector Current - Continuous		100	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES

1) These ratings are based on a maximum junction temperature of 150 degrees C.

### Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units
		2N5088 2N5089	*MMBT5088 *MMBT5089	
P <sub>D</sub>	Total Device Dissipation	625	350	mW
	Derate above 25°C	5.0	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

<sup>2)</sup> These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

(continued)

### **Electrical Characteristics**

TA = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	ıs	Min	Max	Units
OFF CHAF	RACTERISTICS					
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	Ic = 1.0 mA, I <sub>B</sub> = 0	5088 5089	30 25		V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	$I_C = 100 \ \mu A, \ I_E = 0$	5088 5089	35 30		V V
I <sub>CBO</sub>	Collector Cutoff Current	V <sub>CB</sub> = 20 V, I <sub>E</sub> = 0 V <sub>CB</sub> = 15 V, I <sub>E</sub> = 0	5088 5089		50 50	nA nA
I <sub>EBO</sub>	Emitter Cutoff Current	V <sub>EB</sub> = 3.0 V, I <sub>C</sub> = 0 V <sub>EB</sub> = 4.5 V, I <sub>C</sub> = 0			50 100	nA nA
ON CHAR	ACTERISTICS					
h <sub>FE</sub>	DC Current Gain	$I_C = 100 \mu A, V_{CE} = 5.0 V$ $I_C = 1.0 mA, V_{CE} = 5.0 V$	5088 5089 5088 5089	300 400 350 450	900 1200	
		$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}^*$	5088 5089	300 400		
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	Ic = 10 mA, I <sub>B</sub> = 1.0 mA			0.5	V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$			0.8	V

### SMALL SIGNAL CHARACTERISTICS

f <sub>T</sub>	Current Gain - Bandwidth Product	$I_C = 500 \mu A, V_{CE} = 5.0 \text{ mA},$ f = 20  MHz	50		MHz
C <sub>cb</sub>	Collector-Base Capacitance	$V_{CB} = 5.0 \text{ V}, I_E = 0, f = 100 \text{ kHz}$		4.0	pF
C <sub>eb</sub>	Emitter-Base Capacitance	$V_{BE} = 0.5 \text{ V}, I_{C} = 0, f = 100 \text{ kHz}$		10	pF
h <sub>fe</sub>	Small-Signal Current Gain	I <sub>C</sub> = 1.0 mA, V <sub>CE</sub> = 5.0 V, <b>5088</b> f = 1.0 kHz <b>5089</b>	350 450	1400 1800	
NF	Noise Figure	$I_C = 100 \ \mu A, \ V_{CE} = 5.0 \ V, \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $		3.0 2.0	dB dB

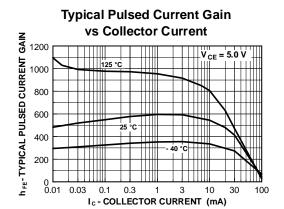
<sup>\*</sup>Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

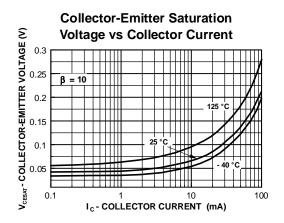
### **Spice Model**

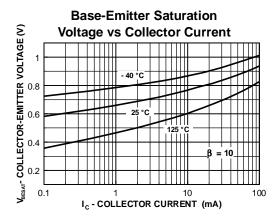
 $NPN \ (Is=5.911f \ Xti=3 \ Eg=1.11 \ Vaf=62.37 \ Bf=1.122K \ Ne=1.394 \ Is=5.911f \ Ikf=14.92m \ Xtb=1.5 \ Br=1.271 \ Nc=2 \ Isc=0 \ Ikr=0 \ Rc=1.61 \ Cjc=4.017p \ Mjc=.3174 \ Vjc=.75 \ Fc=.5 \ Cje=4.973p \ Mje=.4146 \ Vje=.75 \ Tr=4.673n \ Tf=821.7p \ Itf=.35 \ Vtf=4 \ Xtf=7 \ Rb=10)$ 

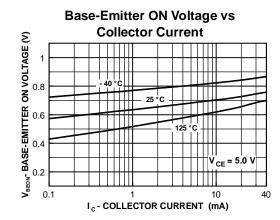
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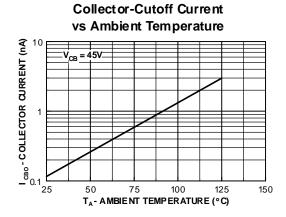
## **Typical Characteristics**







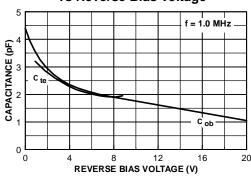




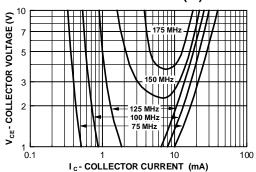
(continued)

### Typical Characteristics (continued)

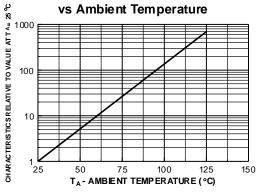
## Input and Output Capacitance vs Reverse Bias Voltage



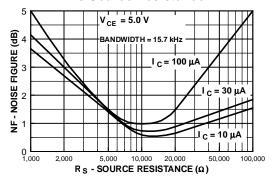
## Contours of Constant Gain Bandwidth Product (f<sub>T</sub>)



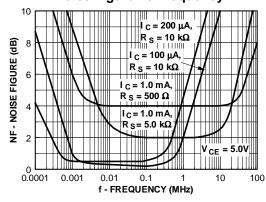
Normalized Collector-Cutoff Current vs Ambient Temperature



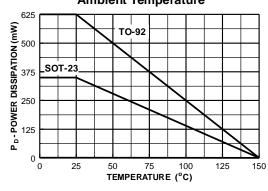
## Wideband Noise Frequency vs Source Resistance



**Noise Figure vs Frequency** 



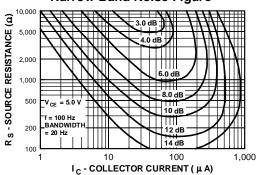
### Power Dissipation vs Ambient Temperature



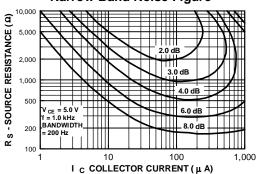
(continued)

### Typical Characteristics (continued)

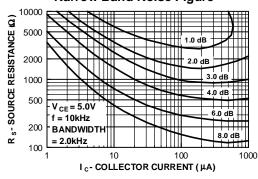
Contours of Constant Narrow Band Noise Figure



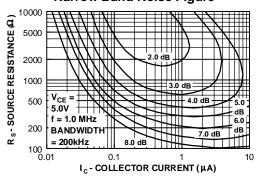
Contours of Constant Narrow Band Noise Figure



Contours of Constant Narrow Band Noise Figure



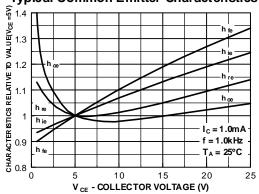
Contours of Constant Narrow Band Noise Figure



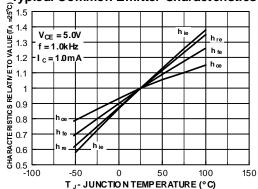
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## **Typical Common Emitter Characteristics** (f = 1.0 kHz)

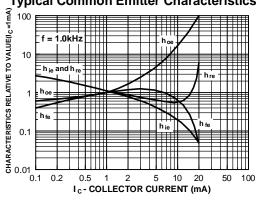




### Typical Common Emitter Characteristics



### **Typical Common Emitter Characteristics**



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